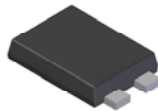


Features

- Guard Ring Die Construction for Transient Protection
- Low Power Loss, High Efficiency
- Low Forward Voltage Drop
- Low Reverse Leakage Current
- For Use in Low Voltage, High Frequency Inverters, Free Wheeling, and Polarity Protection Applications
- High Forward Surge Current Capability
- **Lead Free Finish, RoHS Compliant (Note 1)**
- **"Green" Molding Compound (No Br, Sb)**
- **Qualified to AEC-Q101 Standards for High Reliability**



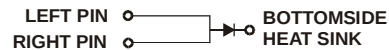
Top View



Bottom View

Mechanical Data

- Case: PowerDI[®]5
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020D
- Terminals: Finish – Matte Tin annealed over Copper leadframe. Solderable per MIL-STD-202, Method 208 **(e3)**
- Polarity: See Diagram
- Marking Information: See page 3
- Ordering Information: See page 3
- Weight: 0.093 grams (approximate)



Note: Pins Left & Right must be electrically connected at the printed circuit board.

Maximum Ratings @T_A = 25°C unless otherwise specified

Single phase, half wave, 60Hz, resistive or inductive load.
 For capacitance load, derate current by 20%.

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage	V _{RRM}	40	V
Working Peak Reverse Voltage	V _{RWM}		
DC Blocking Voltage	V _R		
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current (See also Figure 5)	I _O	3	A
Non-Repetitive Peak Forward Surge Current 8.3ms Single half sine-wave Superimposed on Rated Load	I _{FSM}	90	A

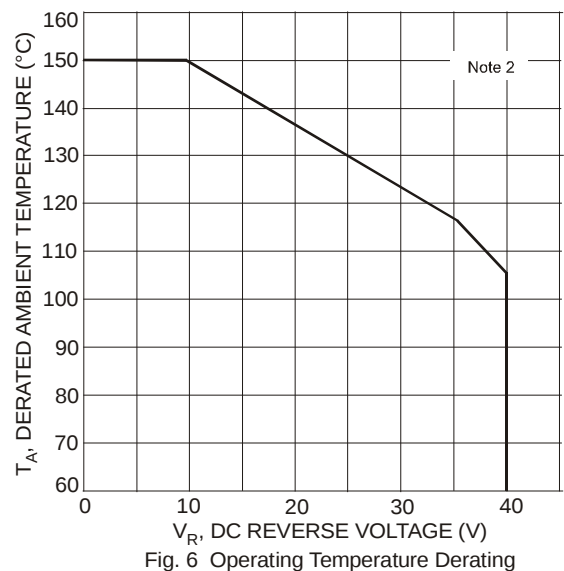
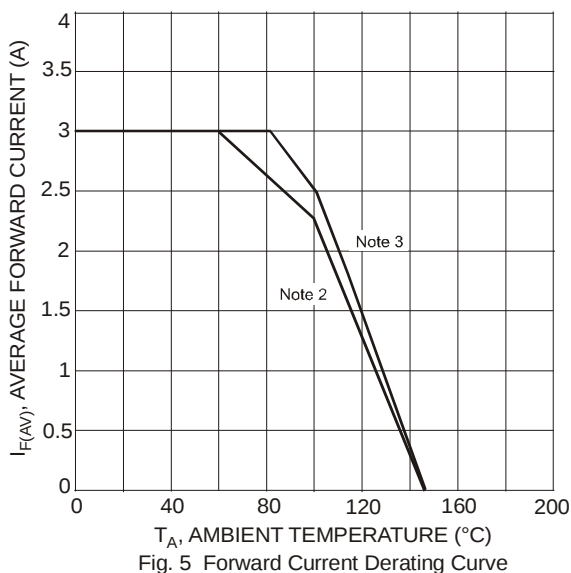
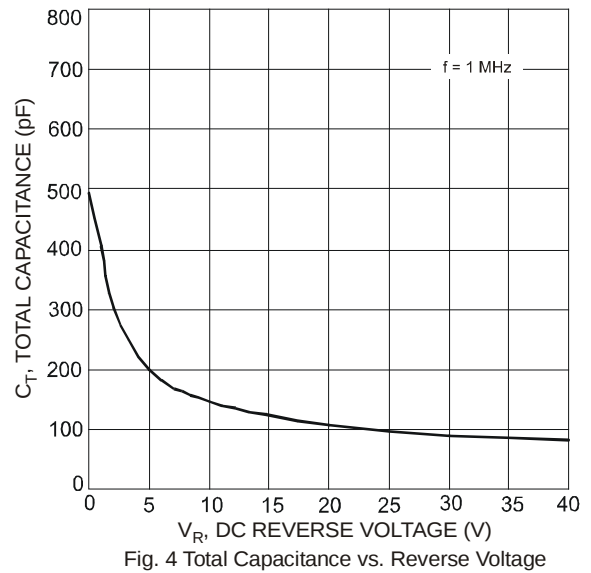
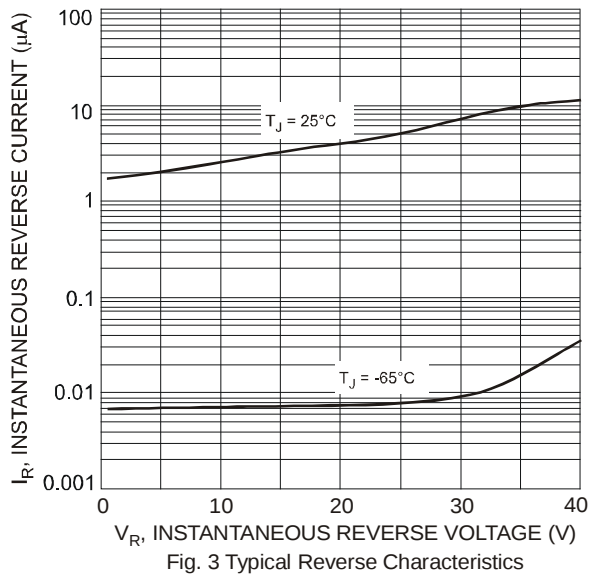
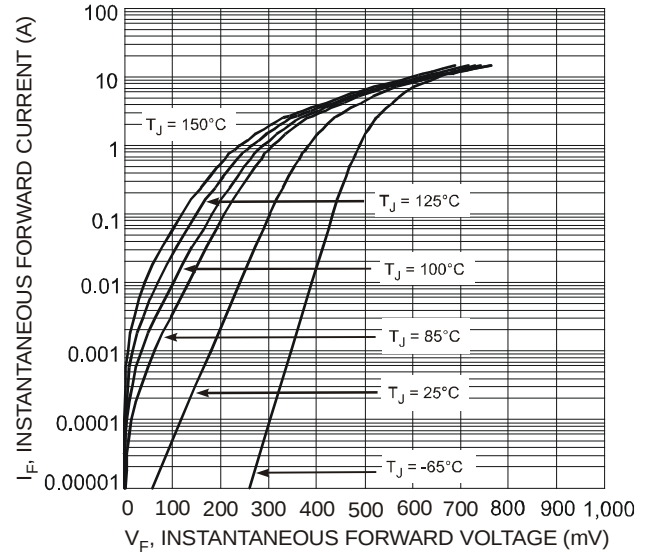
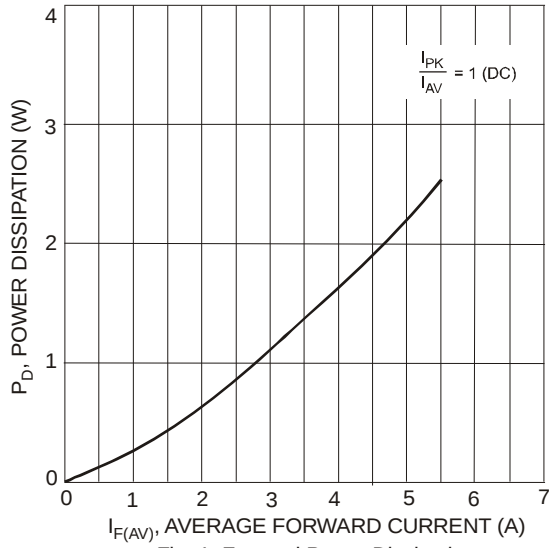
Thermal Characteristics

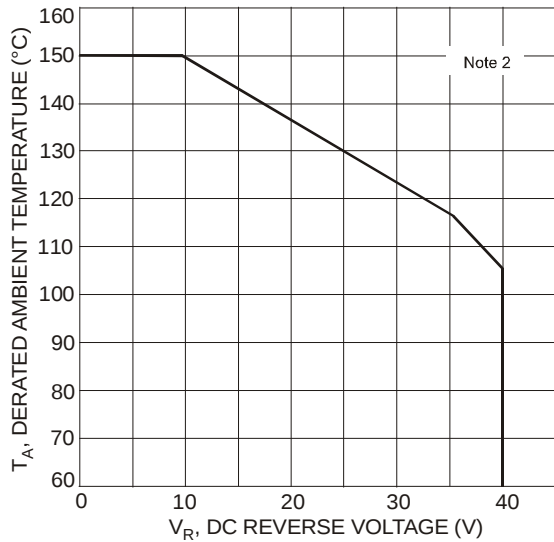
Characteristic	Symbol	Typ	Max	Unit
Thermal Resistance Junction to Soldering Point	R _{θJS}	—	6.0	°C/W
Thermal Resistance Junction to Ambient Air (Note 2) T _A = 25°C	R _{θJA}	95	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 3) T _A = 25°C	R _{θJA}	60	—	°C/W
Thermal Resistance Junction to Ambient Air (Note 4) T _A = 25°C	R _{θJA}	50	—	°C/W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150		°C

Electrical Characteristics @T_A = 25°C unless otherwise specified

Characteristic	Symbol	Min	Typ	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 5)	V _{(BR)R}	40	—	—	V	I _R = 0.5mA
Forward Voltage	V _F	—	0.45	0.49	V	I _F = 3A, T _J = 25°C
		—	0.38	0.42		I _F = 3A, T _J = 125°C
		—	0.53	0.61		I _F = 6A, T _J = 25°C
		—	0.50	0.57		I _F = 6A, T _J = 125°C
Reverse Current (Note 5)	I _R	—	15	500	μA	T _J = 25°C, V _R = 40V
		—	3	20	mA	T _J = 100°C, V _R = 40V
		—	10	25	mA	T _J = 125°C, V _R = 40V

- Notes:
1. EU Directive 2002/95/EC (RoHS). All applicable RoHS exemptions applied, see *EU Directive 2002/95/EC Annex Notes*.
 2. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 3. Polyimide PCB, 2 oz. Copper, minimum recommended pad layout per <http://www.diodes.com/datasheets/ap02001.pdf>.
 4. Polyimide PCB, 2 oz. Copper. Cathode pad dimensions 6.5mm x 5.0mm. Anode pad dimensions 1.8mm x 1.1mm.
 5. Short duration pulse test used to minimize self-heating effect.



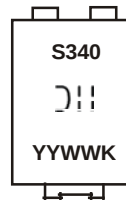


Ordering Information (Note 6)

Part Number	Case	Packaging
PDS340-13	PowerDI [®] 5	5000/Tape & Reel

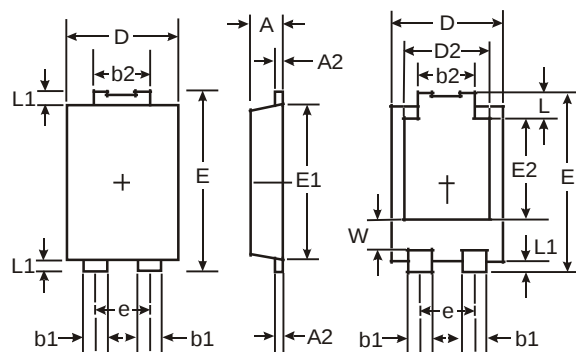
Notes: 6. For packaging details, go to our website at <http://www.diodes.com/datasheets/ap02007.pdf>.

Marking Information



S340 = Product type marking code
 ☺ = Manufacturers' code marking
 YYWW = Date code marking
 YY = Last digit of year ex: 04 for 2004
 WW = Week code 01 to 52
 K = Factory Designator

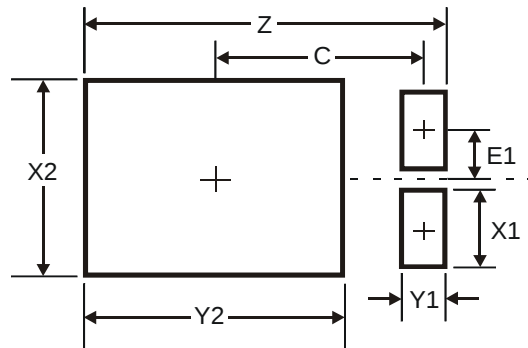
Package Outline Dimensions



PowerDI [®] 5		
Dim	Min	Max
A	1.05	1.15
A2	0.33	0.43
b1	0.80	0.99
b2	1.70	1.88
D	3.90	4.05
D2	3.05	NOM
E	6.40	6.60
e	1.84	NOM
E1	5.30	5.45
E2	3.55	NOM
L	0.75	0.95
L1	0.50	0.65
W	1.20	1.50
All Dimensions in mm		

PowerDI is a registered trademark of Diodes Incorporated.

Suggested Pad Layout



Dimensions	Value (in mm)
Z	6.6
X1	1.4
X2	3.6
Y1	0.8
Y2	4.7
C	3.87
E1	0.9

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